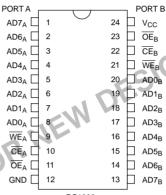


# **DS1609**Dual Port RAM

#### **FEATURES**

- Totally asynchronous 256-byte dual port memory
- Multiplexed address and data bus keeps pin count low
- Dual port memory cell allows random access with minimum arbitration
- Each port has standard independent RAM control signals
- Fast access time
- Low power CMOS design
- 24-pin DIP or 24-pin SOIC surface mount package
- Both CMOS and TTL compatible
- Operating temperature of -40°C to +85°C
- Standby current of 100 nA @ 25°C makes the device ideal for battery backup or battery operate applications

#### **PIN ASSIGNMENT**



DS1609 24-PIN DIP (600 MIL) See Mech. Drawings Section

PORT A			PORT B
AD7 <sub>A</sub> □□□	1	24 📖	$V_{CC}$
AD6 <sub>A</sub> □□□	2	23 🞞	OE <sub>B</sub>
AD5 <sub>A</sub> □□□	3	22 📖	CEB
AD4 <sub>A</sub> □□□	4	21 📖	WEB
AD3 <sub>A</sub> □□□	5	20 📖	AD0 <sub>B</sub>
AD2 <sub>A</sub> □□□	6	19 📖	AD1 <sub>B</sub>
AD1 <sub>A</sub> □□□	7	18 🎹	AD2 <sub>B</sub>
ADO <sub>A</sub> IIII	8	17 📖	AD3 <sub>B</sub>
WEA III	9	16 📖	AD4 <sub>B</sub>
CE <sub>A</sub> IIII	10	15 📖	AD5 <sub>B</sub>
OE <sub>A</sub> IIII	11	14 📖	AD6 <sub>B</sub>
GND Ⅲ	12	13 📖	AD7 <sub>B</sub>

DS1609S 24-PIN SOIC (300 MIL) See Mech. Drawings Section

#### **PIN DESCRIPTION**

 AD0-AD7
 Port address/data

 CE
 Port enable

 WE
 Write enable

 OE
 Output enable

 V<sub>CC</sub>
 +5 volt supply

 GND
 Ground

#### **DESCRIPTION**

The DS1609 is a random access 256-byte dual port memory designed to connect two asyncronous address/data buses together with a common memory element. Both ports have unrestricted access to all 256 bytes of memory, and with modest system discipline no arbitration is required. Each port is controlled

by three control signals: output enable, write enable, and port enable. The device is packaged in plastic 24–pin DIP and 24–pin SOIC. Output enable access time of 50 ns is available when operating at 5 volts.

ABSOLUTE MAXIMUM RATINGS\* Voltage on Any Pin Relative to Ground -0.5V to +7.0V Operating Temperature Storage Temperature -40°C to +85°C -55°C to +125°C Soldering Temperature 260°C for 10 seconds

### RECOMMENDED DC OPERATING CONDITIONS

(-40°C to +85°C)

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PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	NOTES
Power Supply	V <sub>CC</sub>	4.5	5.0	5.5	V	1
Input Logic 1	V <sub>IH</sub>	2.0		V <sub>CC</sub> + 0.3	V C	7
Input Logic 0	V <sub>IL</sub>	-0.3		+0.8	٧	1

#### DC ELECTRICAL CHARACTERISTICS

 $(-40^{\circ}\text{C to } +85^{\circ}\text{C}; V_{CC} = 5\text{V} \pm 10\%)$ 

PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	NOTES
Input Impedance	Z <sub>IN</sub>	50K	60.		Ω	2
CE, WE, OE Leakage	I <sub>LO</sub>	-1.0		+1.0	μΑ	
Standby Current	I <sub>CCS1</sub>	V	3.0	5.0	mA	3, 4, 13
Standby Current	I <sub>CCS2</sub>		50	300	μΑ	3, 5, 13
Standby Current	I <sub>CCS3</sub>		100		nA	3, 6, 13
Operating Current	I <sub>CC</sub>		18	30	mA	7, 13
Logic 1 Output	V <sub>OH</sub>	2.4			V	8
Logic 0 Output	V <sub>OL</sub>			0.4	V	9

#### **CAPACITANCE** $(t_A = 25^{\circ}C)$

PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	NOTES
Input Capacitance	C <sub>IN</sub>		5	10	pF	
I/O Capacitance	C <sub>I/O</sub>		5	10	pF	

<sup>\*</sup> This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operation sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability.

#### **AC ELECTRICAL CHARACTERISTICS**

 $(-40^{\circ}\text{C to } +85^{\circ}\text{C}; \text{V}_{\text{CC}} = 5\text{V} \pm 10\%)$ 

PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	NOTES
Address Setup Time	t <sub>AS</sub>	5			ns	
Address Hold Time	t <sub>AH</sub>	25			ns	
Output Enable Access	t <sub>OEA</sub>	0		50	ns	10
OE to High Z	t <sub>OEZ</sub>	0		20	ns	
CE to High Z	t <sub>CEZ</sub>	0		20	ns	
Data Setup Time	t <sub>DS</sub>	0			ns	
Data Hold Time	t <sub>DH</sub>	10			ns	
Write Pulse Width	t <sub>WP</sub>	50			ns	11
CE Recovery Time	t <sub>CER</sub>	20			ns	12
WE Recovery Time	t <sub>WER</sub>	20		100	ns	12
OE Recovery Time	t <sub>OER</sub>	20		1EA	ns	12
CE to OE Setup Time	tCOE	25	-B		ns	
CE to WE Setup Time	t <sub>CWE</sub>	25	\$O,		ns	

## AC ELECTRICAL CHARACTERISTICS

 $(-40^{\circ}\text{C to } +85^{\circ}\text{C}; V_{\text{CC}} = 2.5\text{V} - 4.5\text{V})$ 

PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	NOTES
Address Setup Time	t <sub>AS</sub>	5			ns	
Address Hold Time	t <sub>AH</sub>	25			ns	
Output Enable Access	t <sub>OEA</sub>	0		100	ns	10
OE to High Z	t <sub>OEZ</sub>	0		20	ns	
CE to High Z	t <sub>CEZ</sub>	0		20	ns	
Data Setup Time	t <sub>DS</sub>	0			ns	
Data Hold Time	t <sub>DH</sub>	10			ns	
Write Pulse Width	t <sub>WP</sub>	100			ns	11
CE Recovery Time	t <sub>CER</sub>	20			ns	12
WE Recovery Time	t <sub>WER</sub>	20			ns	12
OE Recovery Time	t <sub>OER</sub>	20			ns	12
CE to OE Setup Time	t <sub>COE</sub>	25			ns	
CE to WE Setup Time	t <sub>CWE</sub>	25			ns	

#### NOTES:

- 1. All Voltages are referenced to ground.
- 2. All pins other than CE, WE, OE, V<sub>CC</sub> and ground are continuously driven by a feedback latch in order to hold the inputs at one power supply rail or the other when an input is tristated. The minimum driving impedance presented to any pin is 50KΩ. If a pin is at a logic low level, this impedance will be pulling the pin to ground. If a pin is at a logic high level, this impedance will be pulling the pin to V<sub>CC</sub>.
- 3. Standby current is measured with outputs open circuited.
- 4. I<sub>CCS1</sub> is measured with all pins within 0.3V of V<sub>CC</sub> or GND and with  $\overline{\text{CE}}$  at a logic high or logic low level.
- 5.  $I_{CCS2}$  is measured with all pins within 0.3V of  $V_{CC}$  or ground and with  $\overline{CE}$  within 0.3V of  $V_{CC}$ .
- 6. I<sub>CCS3</sub> is measured with all pins at V<sub>CC</sub> or ground potential and with  $\overline{\text{CE}} = \text{V}_{\text{CC}}$ . Note that if a pin is floating, the internal feedback latches will pull all the pins to one power supply rail or the other.
- 7. Active current is measured with outputs open circuited, and inputs swinging full supply levels with one port reading and one port writing at 100 ns cycle time. Active currents are a DC average with respect to the number of 0's and 1's being read or written.
- 8. Logic one voltages are specified at a source current of 1 mA.
- 9. Logic zero voltages are specified at a sink current of 4 mA.
- 10. Measured with a load as shown in Figure 3.
- 11.  $t_{WP}$  is defined as the time from  $\overline{WE}$  going low to the first of the rising edges of  $\overline{WE}$  and  $\overline{CE}$ .
- 12. Recovery time is the amount of time control signals must remain high between successive cycles.
- 13. Typical values are at 25°C

#### **LOAD SCHEMATIC** Figure 3

